

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Materials for printed boards and other interconnecting structures –
Part 2-43: Reinforced base materials clad and unclad – Non-halogenated
epoxide cellulose paper/woven E-glass reinforced laminate sheets of defined
flammability (vertical burning test), copper-clad for lead-free assembly**

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**Matériaux pour circuits imprimés et autres structures d'interconnexion –
Partie 2-43: Matériaux de base renforcés, plaqués et non plaqués – Feuilles
stratifiées renforcées en verre de type E tissé/papier cellulose époxyde non
halogéné, plaquées cuivre, d'inflammabilité définie (essai de combustion
verticale) pour les assemblages sans plomb**



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CONTENTS

FOREWORD	4
1 Scope	6
2 Normative references	6
3 Materials and construction	6
3.1 General	6
3.2 Resin system	6
3.3 Metal foil	7
3.4 Reinforcement	7
4 Internal marking	7
5 Electrical properties	7
6 Non-electrical properties of the copper-clad laminate	7
6.1 Appearance of the copper-clad sheet	7
6.1.1 General	7
6.1.2 Indentations (pits and dents)	8
6.1.3 Wrinkles	8
6.1.4 Scratches	8
6.1.5 Raised areas	8
6.1.6 Surface waviness	9
6.2 Appearance of the unclad face	9
6.3 Laminate thickness	9
6.4 Bow and twist	9
6.5 Properties related to the copper foil bond	10
6.6 Punching and machining	11
6.7 Dimensional stability	11
6.8 Sheet sizes	11
6.8.1 Typical sheet sizes	11
6.8.2 Tolerances for sheet sizes	11
6.9 Cut panels	12
6.9.1 Cut panel sizes	12
6.9.2 Size tolerances for cut panels	12
6.9.3 Rectangularity of cut panels	12
7 Non-electrical properties of the base material after complete removal of the copper foil	12
7.1 Appearance of the dielectric base material	12
7.2 Flexural strength	13
7.3 Flammability	13
7.4 Water absorption	14
7.5 Measling	14
7.6 Glass transition temperature and cure factor	14
7.7 Decomposition temperature	14
7.8 Time to delamination (TMA)	15
8 Quality assurance	15
8.1 Quality system	15
8.2 Responsibility for inspection	15
8.3 Qualification inspection	15
8.4 Quality conformance inspection	15

8.5	Certificate of conformance	15
8.6	Safety data sheet.....	16
9	Packaging and marking	16
10	Ordering information.....	16
	Annex A (informative) Engineering information.....	17
A.1	General	17
A.2	Chemical properties	17
A.3	Electrical properties	17
A.4	Flammability properties	17
A.5	Mechanical properties	17
A.6	Physical properties	17
A.7	Thermal properties.....	17
	Annex B (informative) Common laminate constructions	19
	Annex C (informative) Guideline for qualification and conformance inspection	20
	Bibliography	21
	Table 1 – Electrical properties	7
	Table 2 – Size and indentations	8
	Table 3 – Nominal thickness and tolerance of metal-clad laminate.....	9
	Table 4 – Bow and twist requirements.....	10
	Table 5 – Pull-off and peel strength requirements.....	10
	Table 6 – Dimensional stability	11
	Table 7 – Size tolerances for cut panels.....	12
	Table 8 – Rectangularity of cut panels.....	12
	Table 9 – Flexural strength requirements	13
	Table 10 – Flammability requirements.....	13
	Table 11 – Water absorption requirements.....	14
	Table 12 – Measling requirements	14
	Table 13 – Glass transition temperature and cure factor requirements.....	14
	Table 14 – Decomposition temperature requirements	14
	Table 15 – Time to delamination requirements	15
	Table C.1 – Qualification and conformance inspection.....	20

INTERNATIONAL ELECTROTECHNICAL COMMISSION

MATERIALS FOR PRINTED BOARDS AND OTHER INTERCONNECTING STRUCTURES –

Part 2-43: Reinforced base materials clad and unclad – Non-halogenated epoxide cellulose paper/woven E-glass reinforced laminate sheets of defined flammability (vertical burning test), copper-clad for lead-free assembly

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The text of this standard is based on the following documents:

FDIS	Report on voting
91/1350/FDIS	91/1363/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

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1 Scope

This part of IEC 61249 gives requirements for properties of non-halogenated epoxide cellulose paper reinforced core/woven E-glass reinforced surface laminate sheets of defined flammability (vertical burning test), copper-clad for lead-free assembly in thicknesses of 0,60 mm up to 1,70 mm. The flammability rating is achieved through the use of non-halogenated fire retardants reacted as part of the epoxide polymeric structure. The glass transition temperature is defined to be 100 °C minimum.

Some property requirements may have several classes of performance. The class desired should be specified on the purchase order, otherwise the default class of material will be supplied.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61189-2:2006, *Test methods for electrical materials, printed boards and other interconnection structures and assemblies – Part 2: Test methods for materials for interconnection structures*

IEC 61249-5-1, *Materials for interconnection structures – Part 5: Sectional specification set for conductive foils and films with and without coatings – Section 1: Copper foils (for the manufacture of copper-clad base materials)*

IEC PAS 61249-6-3, *Specification for finished fabric woven from "E" glass for printed boards*

ISO 11014, *Safety data sheet for chemical products – Content and order of sections*

3 Materials and construction

3.1 General

The sheet consists of an insulating base with metal-foil bonded to one side or both.

3.2 Resin system

Non-halogen epoxide, filled or unfilled, resulting in a laminate with a glass transition temperature of 100 °C minimum. The maximum total halogens contained in the resin plus reinforcement matrix is $1,5 \times 10^{-3}$ parts (1 500 ppm) with a maximum chlorine of 9×10^{-4} parts (900 ppm) parts and maximum bromine being 9×10^{-4} parts (900 ppm).

Contrast agents may be added to enhance processing such as automated optical inspection (AOI).

Its flame resistance is defined in terms of the flammability requirements of 7.3.

3.3 Metal foil

Copper as specified in IEC 61249-5-1. The preferred foils are electrodeposited of defined ductility.

3.4 Reinforcement

Woven E-glass as specified in IEC PAS 61249-6-3, woven E-glass fabric (for the manufacture of prepreg and copper clad material) as the surface sheet on each side of a core reinforcement comprised of cellulose paper.

4 Internal marking

Not specified.

5 Electrical properties

The electrical property requirements are shown in Table 1.

Table 1 – Electrical properties

Property	Test method	Requirements
Surface resistance after damp heat while in the humidity chamber	2E04	$\geq 3\ 000\ \text{M}\Omega$
Surface resistance after damp heat and recovery (optional)	2E03	$\geq 30\ 000\ \text{M}\Omega$
Volume resistivity after damp heat while in the humidity chamber	2E04	$\geq 1\ 000\ \text{M}\Omega\text{m}$
Volume resistivity after damp heat and recovery (optional)	2E04	$\geq 5\ 000\ \text{M}\Omega\text{m}$
Relative permittivity after damp heat and recovery (1 MHz)	2E10	$\leq 5,4$
Dissipation factor after damp heat and recovery (1 MHz)	2E10	$\leq 0,045$
Arc resistance	2E14	$\geq 60\ \text{s}$
Dielectric breakdown	2E15	$\geq 40\ \text{kV}$
Surface resistance at 125 °C	2E07	$\geq 1\ 000\ \text{M}\Omega$
Volume resistivity at 125 °C	2E07	$\geq 1\ 000\ \text{M}\Omega\text{m}$

6 Non-electrical properties of the copper-clad laminate

6.1 Appearance of the copper-clad sheet

6.1.1 General

The copper-clad face shall be substantially free from defects that may have an impact on the material's fitness for use for the intended purpose.

For the following specific defects, the requirements given shall apply when inspection is made in accordance with IEC 61189-2, method 2M18.

6.1.2 Indentations (pits and dents)

The size of an indentation, usually the length, shall be determined and given a point value to be used as measure of the quality as indicated in Table 2.

Table 2 – Size and indentations

Size mm	Point value for each indentation
0,13 to 0,25	1
0,26 to 0,50	2
0,51 to 0,75	4
0,76 to 1,00	7
Over 1,00	30

The total point count for any 300 mm × 300 mm area shall be calculated to determine the class of the material.

- Class A 29 maximum
- Class B 17 maximum
- Class C 5 maximum
- Class D 0
- Class X To be agreed upon by user and supplier

The required class of material shall be specified in the purchase order. Class A applies unless otherwise specified.

6.1.3 Wrinkles

There shall be no wrinkles in the copper surface.

The inspection area shall exclude a 13 mm border from the edge of the panel or sheet.

6.1.4 Scratches

Scratches deeper than 10 µm or 20 % of the nominal thickness of the foil thickness, whichever is lower, are not permitted.

Scratches with a depth less than 5 % of the nominal thickness of the foil shall not be counted unless this depth is 10 µm or more.

Scratches with a depth between 5 % and 20 % of the nominal thickness of the foil are permitted to a total length of 100 mm for a 300 mm × 300 mm area.

The inspection area shall exclude a 13 mm border from the edge of the panel or sheet.

6.1.5 Raised areas

Raised areas are usually impressions in the press plates used during manufacture but may also be caused by blisters or inclusions of foreign particles under the foil.

Raised areas caused by blisters or inclusions are not permitted.

Raised areas being impressions of defects in press plates are permitted to the following extent:

- Class A and X material maximum height 15 μm and maximum length 15 mm;
- Class B and C material maximum height 8 μm and maximum length 15 mm;
- Class D material maximum height 5 μm and maximum length 15 mm.

6.1.6 Surface waviness

Under consideration.

6.2 Appearance of the unclad face

The unclad face of a single side clad sheet shall have the natural appearance resulting from the curing process. Small irregularities in colour are permitted. The gloss of the unclad face shall be that given by the press plate, release film, or release foil used. Variations of gloss due to the impact of pressure of gases released during the curing are permitted.

6.3 Laminate thickness

If the copper-clad laminate is tested in accordance with test method 2D01 of IEC 61189-2, the thickness shall not depart from the nominal thickness by more than the appropriate value shown in Table 3. The fine tolerances shall apply unless the other tolerances are ordered.

Table 3 – Nominal thickness and tolerance of metal-clad laminate

Property	Test method IEC 61189-2	Nominal thickness including metal foil mm IEC 61249-2-43:2016	Tolerance requirement \pm mm		
			Coarse	Fine	Extra fine
Thickness	2D01	$\geq 0,60 < 0,80$	0,08	0,06	0,05
		$\geq 0,80 < 1,00$	0,17	0,10	0,08
		$\geq 1,00 \leq 1,70$	0,19	0,13	0,08

The thickness and tolerances do not apply to the outer 25 mm of the trimmed master sheet or the outer 13 mm of the cut-to-size panel as manufactured and delivered by the supplier. At no point shall the thickness vary from the nominal thickness by a value greater than 125 % of the specified tolerance.

6.4 Bow and twist

When the copper-clad laminate is tested in accordance with test method 2M01 of IEC 61189-2, the bow and twist shall not exceed the values given in Table 4.

Table 4 – Bow and twist requirements

Property	Test method IEC 61189-2	Nominal thickness mm	Panel dimension longest side mm	Requirements %	
				Copper foil on one side	Copper foil on both sides
Bow and twist	2M01	≥0,6 ≤ 1,3	≤350	≤3,0	≤2,5
			>350 ≤ 500	≤2,8	≤2,3
			>500	≤2,5	≤2,0
		>1,3 < 1,7	≤350	≤2,5	≤2,0
			>350 ≤ 500	≤2,3	≤1,8
			>500	≤2,0	≤1,5
The requirements for bow and twist apply only to one sided copper-clad laminates with maximum foil thickness of 105 μm (915 g/m ²) and double sided copper-clad laminates with maximum foil thickness difference of 70 μm (610 g/m ²).					
Requirements for laminates with copper foil configurations beyond these limits should be subject to agreement between purchaser and supplier.					

6.5 Properties related to the copper foil bond

Pull-off and peel strength requirements are shown in Table 5. These requirements apply to copper foil with a normal profile depth.

Table 5 – Pull-off and peel strength requirements

Property	Test method IEC 61189-2	Requirements		
Pull-off strength	2M05	IEC 61249-2-43:2016		
		Thickness of the copper foil		
		18 μm (152 g/m ²)	≥35 μm (305 g/m ²)	≥70 μm (610 g/m ²)
Peel strength after heat shock 288 °C, 20 s	2M14	≥1,0 N/mm	≥1,2 N/mm	≥1,6 N/mm
		No blistering nor delamination		
Peel strength after dry heat 125 °C	2M15	Under consideration	Under consideration	Under consideration
		No blistering nor delamination		
Peel strength after exposure to solvent vapour. Solvents as agreed upon between purchaser and supplier	2M06	≥1,0 N/mm	≥1,2 N/mm	≥1,4 N/mm
		No blistering nor delamination		
Peel strength after simulated plating	2M16	Under consideration	Under consideration	Under consideration
		No blistering nor delamination		
Peel strength at high temperature Temperature 100 °C (optional)	2M17	Not specified	Not specified	Not specified
Blistering after 288 °C, 20 s heat shock	2C05	No blistering nor delamination		
In case of difficulty due to breakage of the foil or reading range of the force measuring device, the measurement of peel strength at high temperature may be carried out using conductor widths of more than 3 mm.				

6.6 Punching and machining

The laminate shall, in accordance with the manufacturer's recommendations, be capable of being punched, sheared or drilled. Delamination at the edges due to the shearing process is permissible, provided that the depth of delamination is not larger than the thickness of the base material. Delamination at the edges of drilled holes due to the drilling process is not permissible.

A suitable test method for evaluating punching is 2M19 of IEC 61189-2. Requirements for punching force and pull-out force are matters for agreement between user and supplier.

6.7 Dimensional stability

When specimens are tested in accordance with IEC 61189-2, 2X02, the observed tolerance shall be as specified in Table 6. The nominal dimensional stability value shall be as agreed upon between user and vendor. The tolerance range around the agreed upon nominal range shall be range B unless otherwise specified on the purchase order.

Table 6 – Dimensional stability

Property	Test method IEC 61189-2	Class	Requirement μm/m
Dimensional stability	2X02	A	±600
		B	±400
		C	±200
		X	As agreed upon between user and supplier

IEC 61249-2-43:2016

The choice of the glass/fabrics and cellulose papers in the construction of the laminate has a significant impact on dimensional stability. Examples of typical constructions used in printed board applications can be found in Annex B. Annex B is not a construction requirement table but is presented for engineering information only.

Class A performance shall apply unless otherwise noted on the purchase order.

6.8 Sheet sizes

6.8.1 Typical sheet sizes

Sheet sizes are matters of agreement between purchaser and supplier. However, the recommended sizes are listed below:

- 915 mm × 1 220 mm;
- 1 065 mm × 1 155 mm;
- 1 065 mm × 1 280 mm;
- 1 000 mm × 1 000 mm;
- 1 000 mm × 1 200 mm.

6.8.2 Tolerances for sheet sizes

The size of sheet delivered by the supplier shall not deviate more than $\begin{smallmatrix} +25 \\ -0 \end{smallmatrix}$ mm from the ordered size.